

Adapters for .025"(.635mm) Pitch QFP Devices

Features:

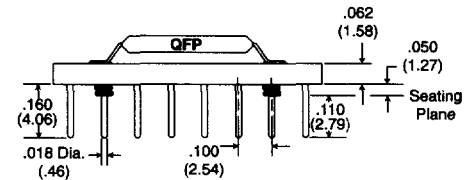
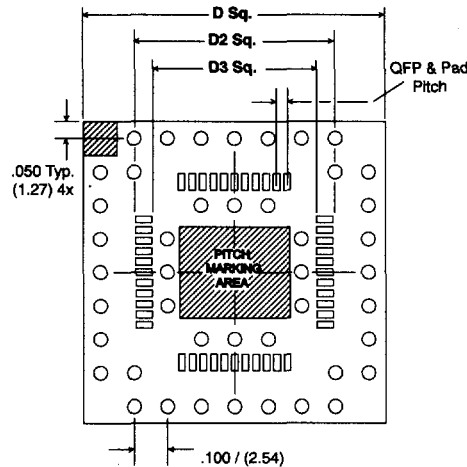
- Adapters for .025" pitch and 0.5, 0.65, 0.8 & 1.0mm pitch QFP's (leaded gull wing type).
- Adapts JEDEC & EIAJ package devices (plastic or ceramic) with SMT footprint to standard PCB PGA footprints.
- .100" (2.54mm) pin to pin PGA footprint spacing allows more space for conductor runs on PCB.
- Radius end of adapter pin to improve socketing.
- PGA sockets available for all footprints shown.
- For custom applications consult factory.

Body Material:

Copper Clad FR-4, Solder Plated

Terminals:

Terminal: Brass Tin-Lead Plated



Device to Adapter Soldering Service Available by Advanced Interconnections

.025" (.635mm) Pitch

Package Style	Part Number	Lead Count	D2	D3	D Max.	PGA Footprint #
Square	3147-44S3	44	.600/(15.24)	.420/(10.67)	.800/(20.32)	44-3
	3147-52S2	52	.650/(16.51)	.470/(11.94)	.900/(22.86)	52-2
	3147-68S4	68	.735/(18.67)	.565/(14.35)	1.100/(22.86)	68-4
	3147-84S9	84	.850/(21.59)	.670/(17.02)	1.100/(22.86)	84-9
	3147-100S9	100	.930/(23.62)	.760/(19.30)	1.200/(30.48)	100-9
	3293-100S	100	.950/(24.13)	.770/(19.56)	1.100/(27.94)	-
	3147-132S5	132	1.130/(28.70)	.974/(24.74)	1.400/(35.56)	132-5
	3293-132S	132	1.150/(29.21)	.970/(24.64)	1.300/(33.02)	-
	3147-144S5	144	1.150/(29.21)	.970/(24.64)	1.600/(40.64)	144-5
	3147-144S6	144	1.375/(34.93)	1.175/(29.85)	1.900/(48.26)	144-6
	3147-144S8	144	1.375/(34.93)	1.090/(27.69)	1.700/(43.18)	144-8
	3147-160S5	160	1.280/(32.51)	1.100/(27.94)	1.700/(43.18)	160-5
	3147-164S1	164	1.325/(33.66)	1.165/(29.59)	1.700/(43.18)	164-1
	3147-244S	244	1.850/(46.99)	1.670/(42.42)	2.200/(55.88)	244

For Pin Out Footprints Consult Full Line Catalog, Website or Factory

Quick turn delivery available.